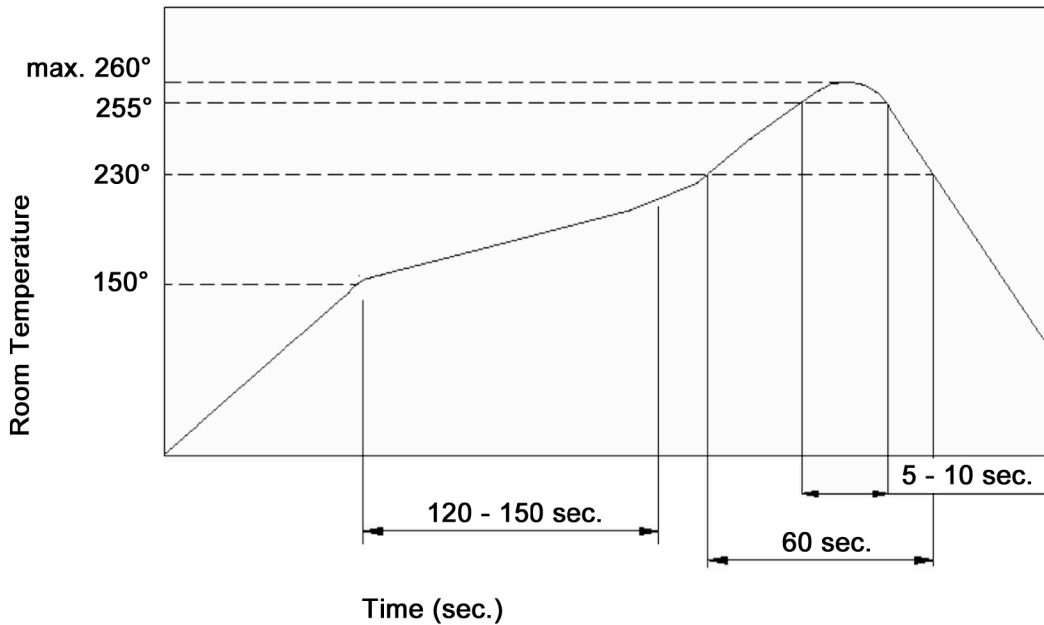




**Soldering conditions:**



- The condition mentioned above is the temperature on the Cu foil of the P.C.B. surface. There are cases where board's temperature greatly differs from switch's surface temperature depending on board's material, size, thickness, etc. Care, therefore, should be used not to allow switch's surface temperature to exceed 260°C.
- Reflow soldering: 230°C, 60sec. max.  
peak temperature: 260°C



|               |      |      |                       |      |                  |      |
|---------------|------|------|-----------------------|------|------------------|------|
| Tolerances:   |      |      | Date                  | Name | <b>TSSE 65 x</b> |      |
|               |      |      | 04/06                 | dr   |                  |      |
|               |      |      |                       |      |                  |      |
|               |      |      |                       |      |                  |      |
|               |      |      |                       |      |                  |      |
|               |      |      | <b>knitter-switch</b> |      | <b>30 08 56</b>  | Page |
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| Modifications | Date | Name |                       |      |                  |      |